

TIL111, TIL114, TIL116, TIL117 OPTOCOUPERS

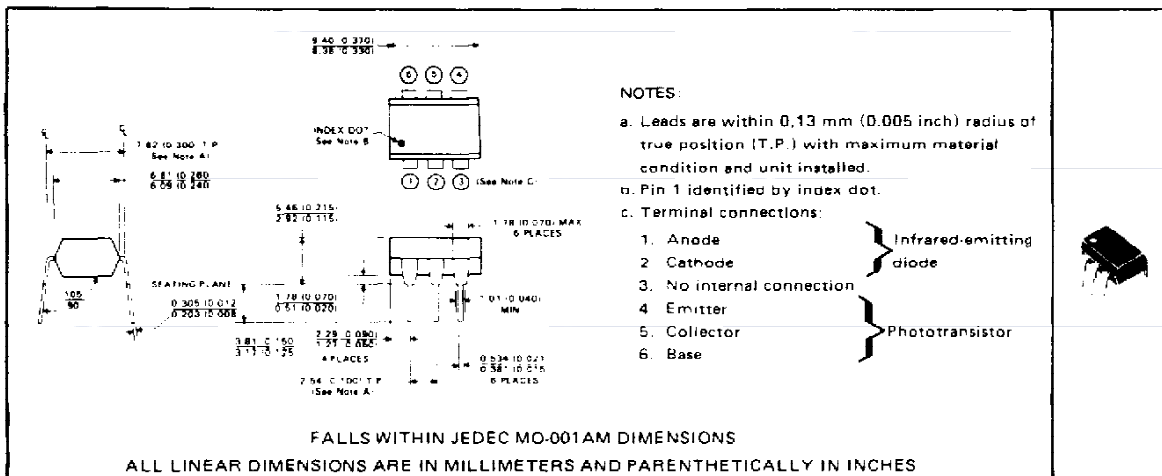
SOOS040 D1607, NOVEMBER 1973-REVISED FEBRUARY 1983

COMPATIBLE WITH STANDARD TTL INTEGRATED CIRCUITS

- Gallium Arsenide Diode Infrared Source Optically Coupled to a Silicon N-P-N Phototransistor
- High Direct-Current Transfer Ratio
- High-Voltage Electrical Isolation . . . 1.5-kV or 2.5-kV Rating
- Plastic Dual-In-Line Package
- High-Speed Switching: $t_r = 5 \mu s$, $t_f = 5 \mu s$ Typical

mechanical data

The package consists of a gallium arsenide infrared-emitting diode and an n-p-n silicon phototransistor mounted on a 6-lead frame encapsulated within an electrically nonconductive plastic compound. The case will withstand soldering temperature with no deformation and device performance characteristics remain stable when operated in high-humidity conditions. Unit weight is approximately 0.52 grams.



absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)

| | |
|---|----------------|
| Input-to-Output Voltage: TIL111 | ±1.5 kV |
| TIL114, TIL116, TIL117 | ±2.5 kV |
| Collector-Base Voltage | 70 V |
| Collector-Emitter Voltage (See Note 1) | 30 V |
| Emitter-Collector Voltage | 7 V |
| Emitter-Base Voltage | 7 V |
| Input-Diode Reverse Voltage | 3 V |
| Input Diode Continuous Forward Current at (or below) 25°C Free Air Temperature (See Note 2) | 100 mA |
| Continuous Power Dissipation at (or below) 25°C Free-Air Temperature: | |
| Infrared-Emitting Diode (See Note 3) | 150 mW |
| Phototransistor (See Note 4) | 150 mW |
| Total, Infrared-Emitting Diode plus Phototransistor (See Note 5) | 250 mW |
| Storage Temperature Range | -55°C to 150°C |
| Lead Temperature 1.6 mm (1/16 Inch) from Case for 10 Seconds | 260°C |

- NOTES:
1. This value applies when the base-emitter diode is open-circuited
 2. Derate linearly to 100°C free-air temperature at the rate of 1.33 mW/°C.
 3. Derate linearly to 100°C free-air temperature at the rate of 2 mW/°C.
 4. Derate linearly to 100°C free-air temperature at the rate of 2 mW/°C.
 5. Derate linearly to 100°C free-air temperature at the rate of 3.33 mW/°C.

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electrical characteristics at 25° C free-air temperature

| PARAMETER | | TEST CONDITIONS | TIL111 TIL114 | | | TIL116 | | | TIL117 | | | UNIT |
|---------------|--|---|------------------|-----|-----|-----------|-----|-----|-----------|-----|-----|----------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | |
| $V_{(BR)CBO}$ | Collector-Base Breakdown Voltage | $I_C = 10 \mu A, I_E = 0, I_F = 0$ | 70 | | | 70 | | | 70 | | | V |
| $V_{(BR)CEO}$ | Collector-Emitter Breakdown Voltage | $I_C = 1 mA, I_B = 0, I_F = 0$ | 30 | | | 30 | | | 30 | | | V |
| $V_{(BR)EBO}$ | Emitter-Base Breakdown Voltage | $I_E = 10 \mu A, I_C = 0, I_F = 0$ | 7 | | | 7 | | | 7 | | | V |
| I_R | Input Diode Static Reverse Current | $V_R = 3 V$ | | 10 | | | 10 | | | 10 | | μA |
| $I_{C(on)}$ | On-State Collector Current | Phototransistor Operation $V_{CE} = 0.4 V, I_F = 16 mA, I_B = 0$ | 2 | 7 | | | | | | | | mA |
| | | $V_{CE} = 10 V, I_F = 10 mA, I_B = 0$ | | | | 2 | 5 | | 5 | 9 | | |
| | Photodiode Operation | $V_{CB} = 0.4 V, I_F = 16 mA, I_E = 0$ | 7 | 20 | | 7 | 20 | | 7 | 20 | | μA |
| $I_{C(off)}$ | Off-State Collector Current | Phototransistor Operation $V_{CE} = 10 V, I_F = 0, I_B = 0$ | | 1 | 50 | | 1 | 50 | | 1 | 50 | nA |
| | | Photodiode Operation $V_{CB} = 10 V, I_F = 0, I_E = 0$ | | 0.1 | 20 | | 0.1 | 20 | | 0.1 | 20 | |
| h_{FE} | Transistor Static Forward Current Transfer Ratio | $V_{CE} = 5 V, I_C = 10 mA, I_F = 0$ | 100 | 300 | | | | | 200 | 550 | | |
| | | $V_{CE} = 5 V, I_C = 100 \mu A, I_F = 0$ | | | | 100 | 300 | | | | | |
| V_F | Input Diode Static Forward Voltage | $I_F = 16 mA$ | 1.2 | 1.4 | | | | | 1.2 | 1.4 | | V |
| | | $I_F = 60 mA$ | | | | 1.25 | 1.5 | | | | | |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | $I_C = 2 mA, I_F = 16 mA, I_B = 0$ | 0.25 | 0.4 | | | | | | | | V |
| | | $I_C = 2.2 mA, I_F = 15 mA, I_B = 0$ | | | | 0.25 | 0.4 | | | | | |
| | | $I_C = 0.5 mA, I_F = 10 mA, I_B = 0$ | | | | | | | 0.25 | 0.4 | | |
| r_{iO} | Input-to-Output Internal Resistance | $V_{in-out} = \pm 1.5 kV$ for TIL111, $\pm 2.5 kV$ for all others, See Note 6 | 10^{11} | | | 10^{11} | | | 10^{11} | | | Ω |
| C_{iO} | Input to-Output Capacitance | $V_{in-out} = 0, f = 1 MHz$, See Note 6 | | 1 | 1.3 | | 1 | 1.3 | | 1 | 1.3 | pF |

NOTE 6 These parameters are measured between both input diode leads shorted together and all the phototransistor leads shorted together.

switching characteristics at 25° C free-air temperature

| PARAMETER | | TEST CONDITIONS | TIL111 TIL114 | | | TIL116 | | | TIL117 | | | UNIT |
|-----------|-----------|--|------------------|-----|-----|--------|-----|-----|--------|-----|-----|---------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | |
| t_r | Rise Time | Phototransistor Operation $V_{CC} = 10 V, I_{C(on)} = 2 mA, R_L = 100 \Omega$, See Test Circuit A of Figure 1 | 5 | 10 | | 5 | 10 | | 5 | 10 | | μs |
| t_f | Fall Time | | 5 | 10 | | 5 | 10 | | 5 | 10 | | |
| t_r | Rise Time | Photodiode Operation $V_{CC} = 10 V, I_{C(on)} = 20 \mu A, R_L = 1 k\Omega$, See Test Circuit B of Figure 1 | 1 | | | 1 | | | 1 | | | μs |
| t_f | Fall Time | | 1 | | | 1 | | | 1 | | | |

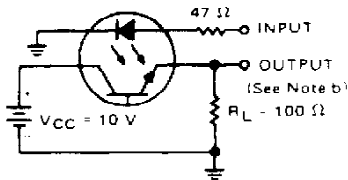
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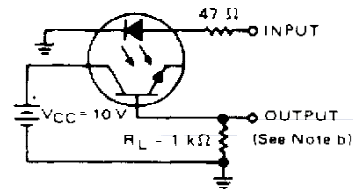
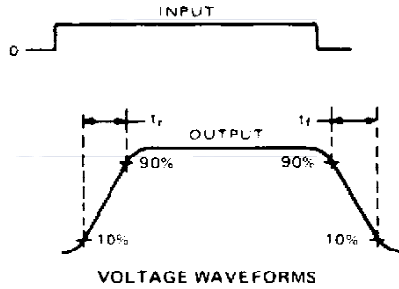
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PARAMETER MEASUREMENT INFORMATION

Adjust amplitude of input pulse for:
 $I_{C(on)} = 2 \text{ mA}$ (Test Circuit A) or
 $I_{C(on)} = 20 \mu\text{A}$ (Test Circuit B)



TEST CIRCUIT A
PHOTOTRANSISTOR OPERATION



TEST CIRCUIT B
PHOTODIODE OPERATION

- NOTES**
- The input waveform is supplied by a generator with the following characteristics: $Z_{out} = 50 \Omega$, $t_r \leq 15 \text{ ns}$, duty cycle $\approx 1\%$, $I_w = 100 \mu\text{s}$.
 - The output waveform is monitored on an oscilloscope with the following characteristics: $t_r \leq 12 \text{ ns}$, $R_{in} \geq 1 \text{ M}\Omega$, $C_{in} \leq 20 \text{ pF}$.

FIGURE 1—SWITCHING TIMES

TYPICAL CHARACTERISTICS

TIL111, TIL114
COLLECTOR CURRENT
vs
INPUT-DIODE FORWARD CURRENT

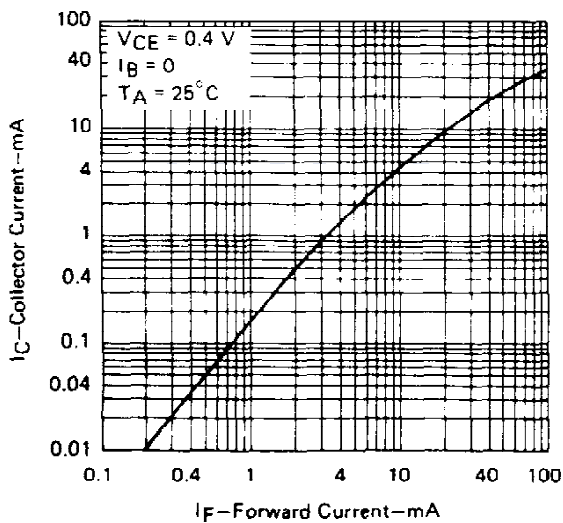


FIGURE 2

TIL116, TIL117
COLLECTOR CURRENT
vs
INPUT-DIODE FORWARD CURRENT

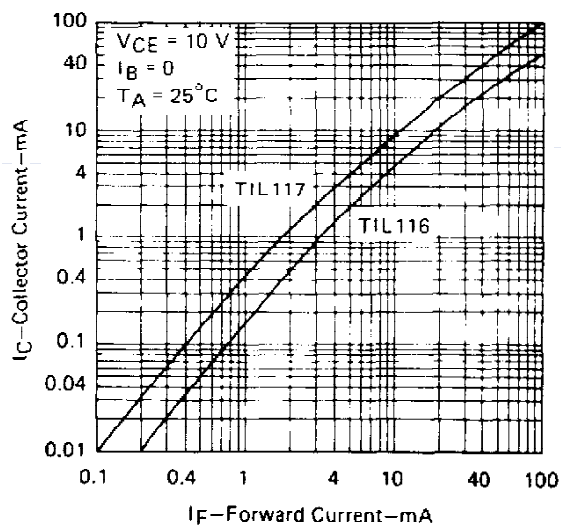


FIGURE 3

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TYPICAL CHARACTERISTICS

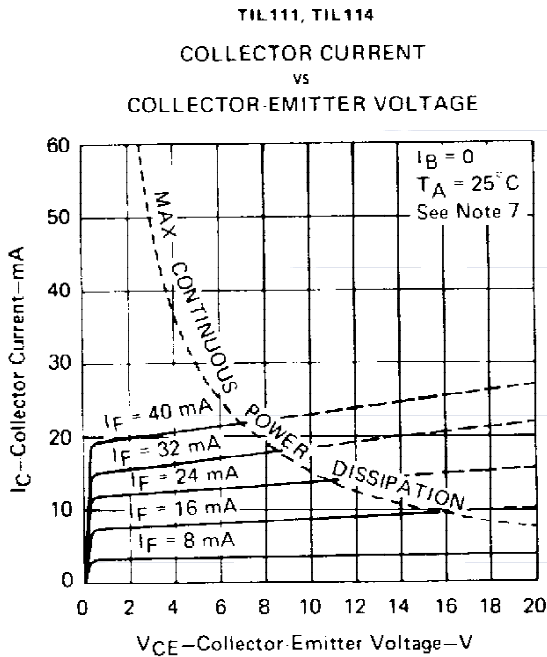


FIGURE 4

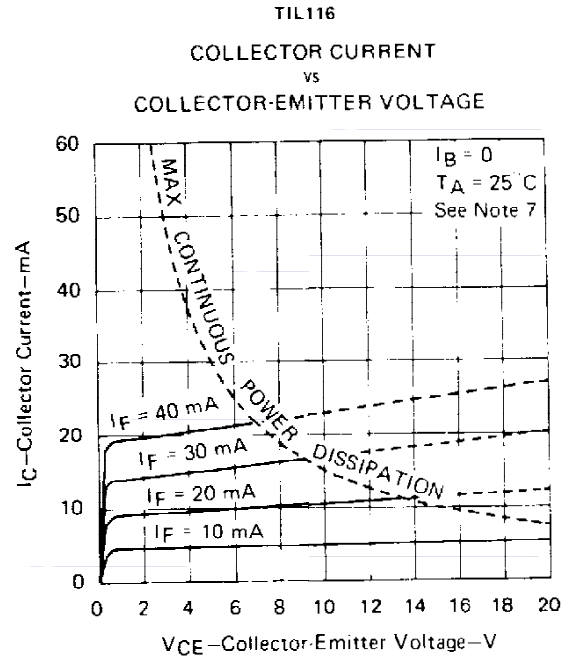


FIGURE 5

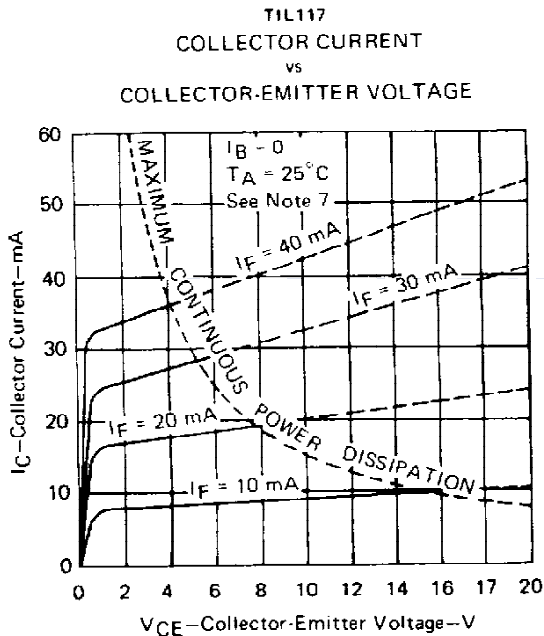


FIGURE 6

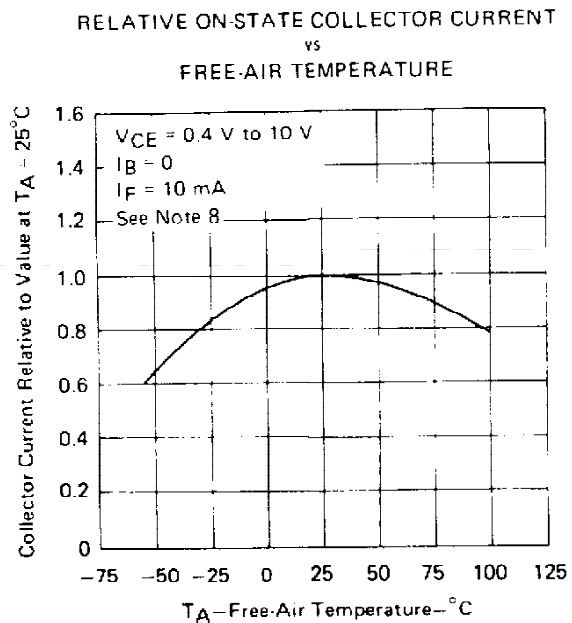


FIGURE 7

NOTES: 7. Pulse operation of input diode is required for operation beyond limits shown by dotted lines.
8. These parameters were measured using pulse techniques: $t_w = 1$ ms, duty cycle $\leq 2\%$.

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TYPICAL CHARACTERISTICS

OFF-STATE COLLECTOR CURRENT
vs
FREE-AIR TEMPERATURE

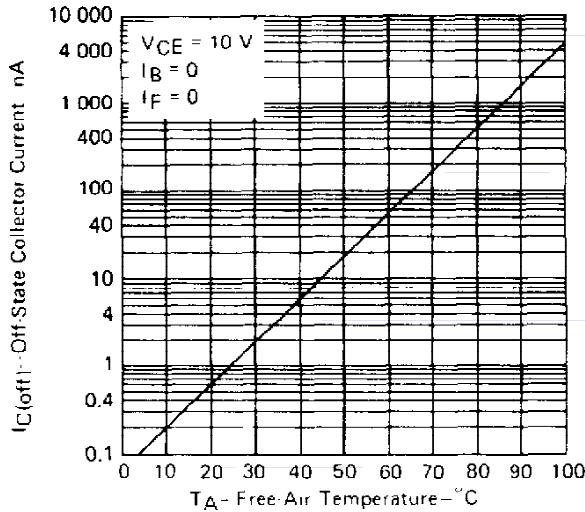


FIGURE 8

NORMALIZED TRANSISTOR STATIC FORWARD
CURRENT TRANSFER RATIO
vs
ON-STATE COLLECTOR CURRENT

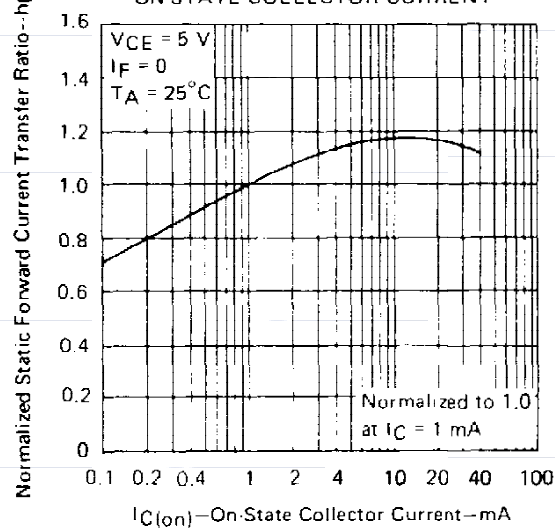


FIGURE 9

INPUT DIODE FORWARD
CONDUCTION CHARACTERISTICS

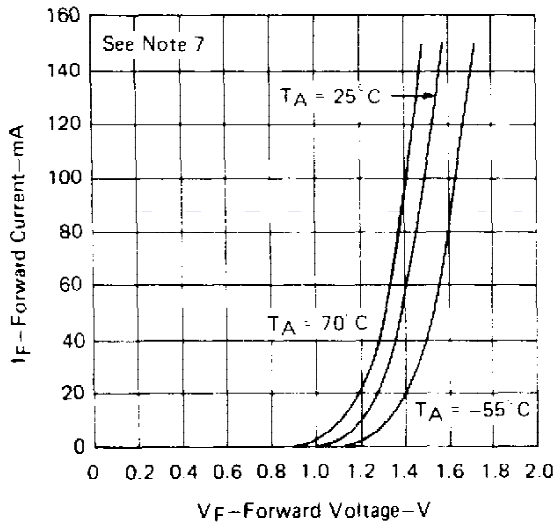


FIGURE 10

COLLECTOR CURRENT
vs
MODULATION FREQUENCY

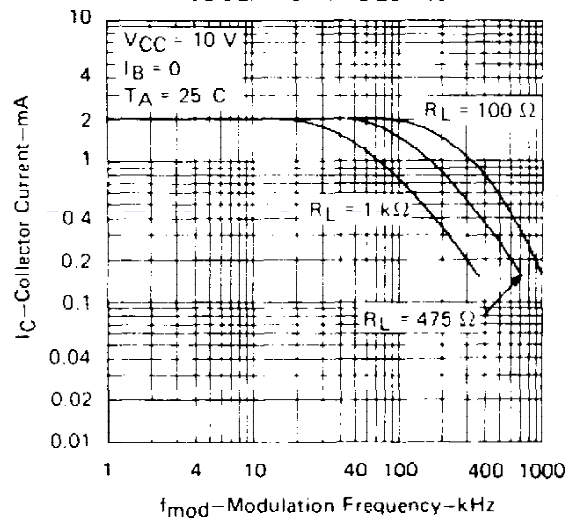


FIGURE 11

NOTE 7: These parameters were measured using pulse techniques. $t_W = 1\text{ ms}$, duty cycle $\leq 2\%$

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